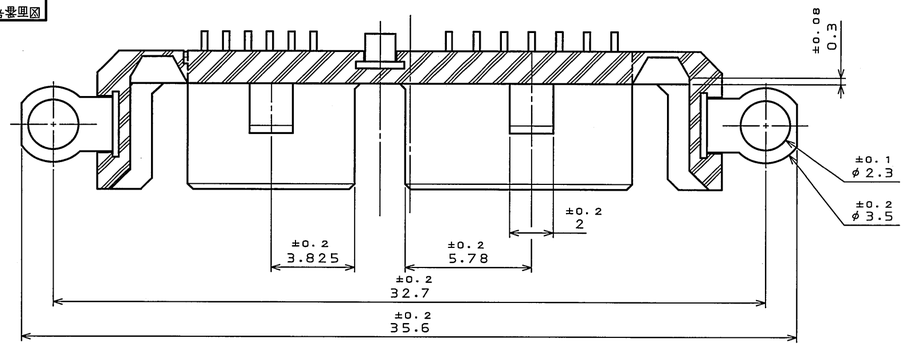
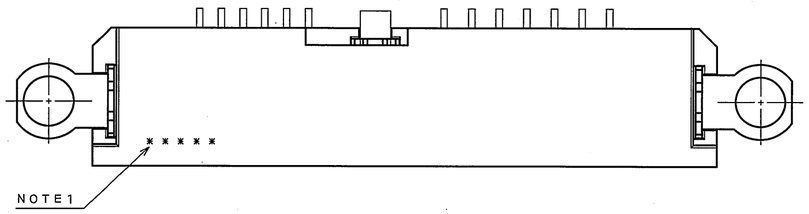
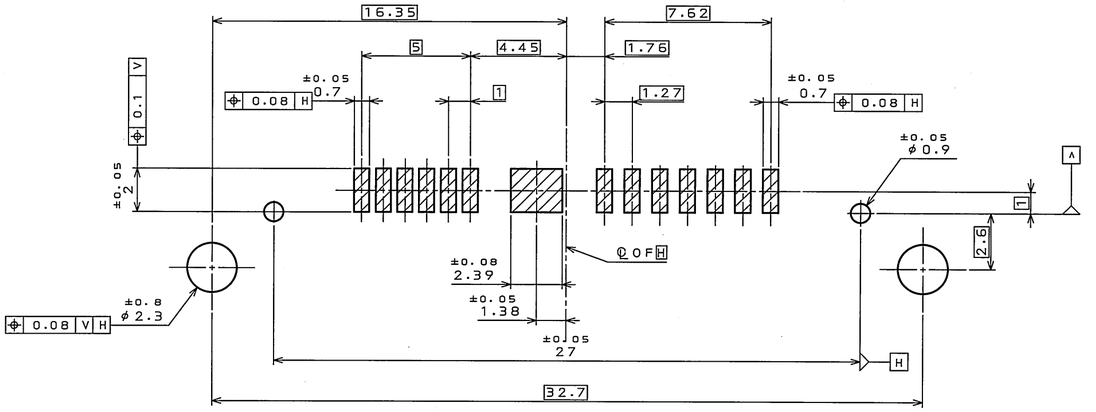
図面番号(DRAWING NO.) SJ107770

| 版数 REV. | 年月日 DATE | DCN NO. | 変更内容 DESCRIPTION | 製図 DR. | 担当 CHK. | 査閲 APPD. | 承認 APPD. |
|---|---|---|---|---|---|---|---|
| 2 | 12.Dec.2007 | 064299 | ADDED ITEMS | | T.MORITAKE | — | Y.YAHIRO |
| | | | | | | | |
| | | | | | | | |

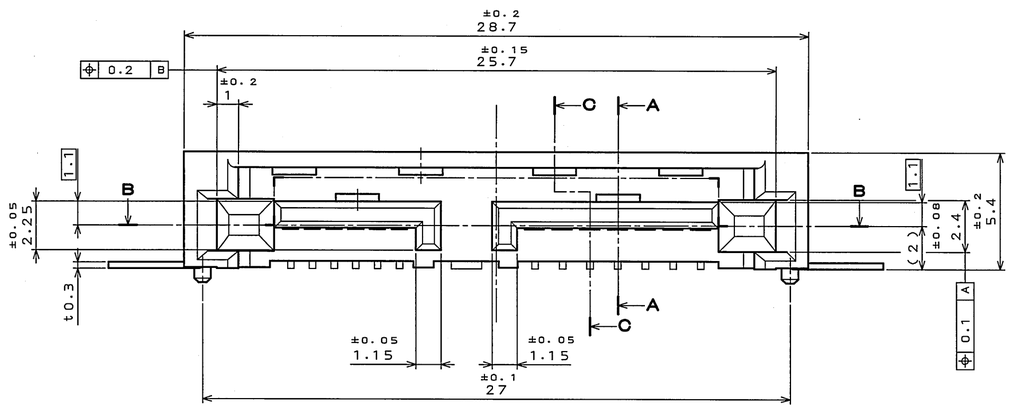


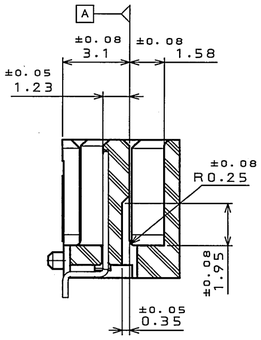

断面B－B
（尺度 5：1）



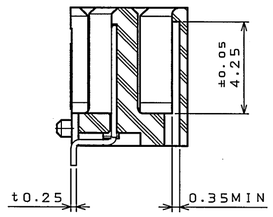




APPLICABLE P.C.B. DIMENSION(REF.)
適合基板寸法（参考）



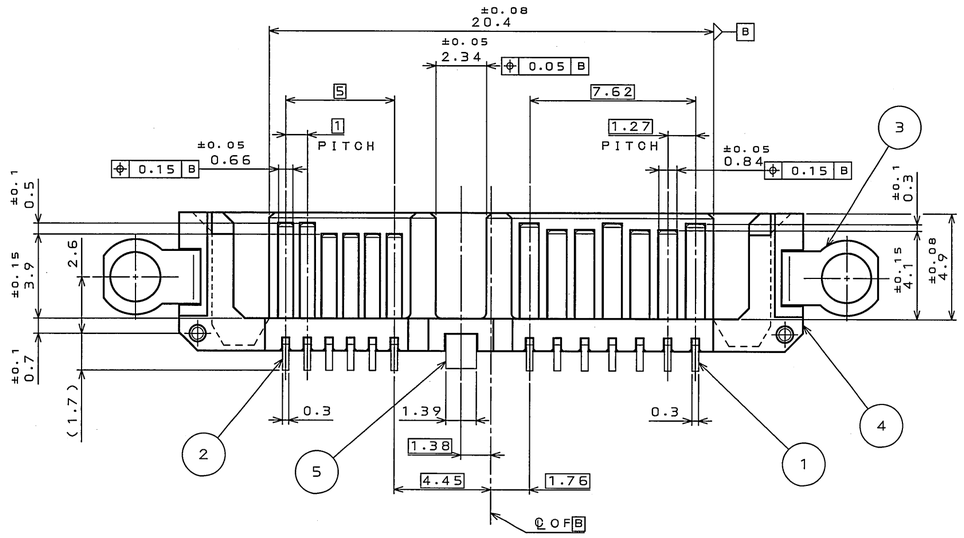

SECT. A－A
(SCALE 5:1)

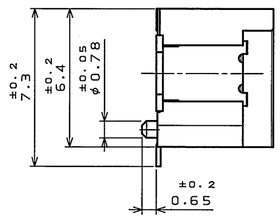



SECT. C－C
(SCALE 5:1)

△1 TABLE 1

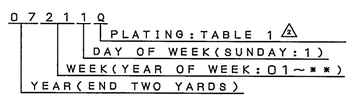
| 品名 TITLE | ロット番号 LOT NO. | 接触部仕上 CONTACT AREA | 端子部仕上 TERMINAL AREA |
|---|---|---|---|
| PM2B013HP1 | ******P | Au 0.1μm MIN OVER Ni | TIN PLATING |
| PM2B013HQ1 | ******Q | Au 0.3μm MIN OVER Ni | TIN PLATING |
| PM2B013HS1 | ******S | Au 0.76μm MIN OVER Ni | TIN PLATING |




NOTE1.PRODUCTION LOT NUMBER AS INDICATED.

(EX.)




△2 2.COPLANARITY:0.1 MAX.

| NO. | 名称 DESCRIPTION | 個数 QTY. | 材料 MATERIAL | 仕上 FINISH | 備考 REMARKS |
|---|---|---|---|---|---|
| 5 | HOLD DOWN3 | 1 | COPPER ALLOY | TIN OVER NICKEL | |
| 4 | INSULATOR | 1 | GLASS FILLED LCP | ——— | UL94V-0 COLOR:BALCK |
| 3 | HOLD DOWN1 | 2 | COPPER ALLOY | TIN OVER NICKEL | |
| 2 | CONTACT2 | 6 | COPPER ALLOY | TABLE 1 △1 | |
| 1 | CONTACT1 | 7 | COPPER ALLOY | TABLE 1 △1 | |

仕様書(SPECIFICATION)

一般公差(GENERAL TOLERANCE)

| 寸法(DIMENSION) | 角度(ANGLES) |
|---|---|
| . ±0.8 | X° ± |
| .X ±0.4 | X°X' ± |
| .XX ±0.1 | |
| .XXX ± | |

| | |
|---|---|
| 第1版(ORIGINAL DATE) | 7.Jun.2007 |
| 製図 DR. | Y.F.LIN |
| 担当 CHK. | T.MORITAKE |
| 査閲 APPD. | ——— |
| 承認 APPD. | Y.YAHIRO |

尺度(SCALE) 5:1
シリーズ(SERIES) PM2
名称(TITLE) △2 PM2B013H**1
質量(MASS)

日本航空電子工業株式会社
JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.
SIZE A2
図面番号(DRAWING NO.) SJ107770
版数(REV.) 2

JAE-CONNECTOR.COM
Reference Only

LEAD FREE この製品は鉛フリー品です

JAE CONNECTOR DIV. PROPRIETARY.
COPYRIGHT (C) 2007, JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.

DOF-0-213F(05.08)

0 10 20 30 40 50 60 70 80 90 100